## **General Description**

The MAX9995 dual, high-linearity, downconversion mixer provides 6.1dB gain, +25.6dBm IIP3, and 9.8dB NF for UMTS/WCDMA, DCS, and PCS base-station applications. The MAX9995 is ideal for low-side LO injection. (For a mixer variant optimized for high-side LO injection, contact the factory.)

This device integrates baluns in the RF and LO ports, a dual-input LO selectable switch, an LO buffer, two doublebalanced mixers, and a pair of differential IF output amplifiers. The MAX9995 requires a typical LO drive of 0dBm and supply current is guaranteed to be below 380mA.

These devices are available in a compact 36-pin thin QFN package (6mm  $\times$  6mm) with an exposed paddle. Electrical performance is guaranteed over the extended temperature range, from T<sub>C</sub> = -40°C to +85°C.

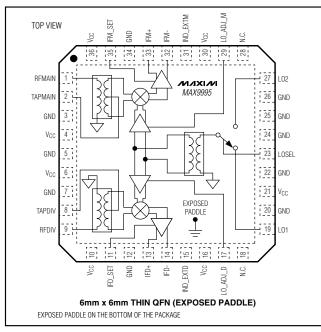
UMTS/WCDMA and cdma2000® 3G Base Stations DCS1800 and EDGE Base Stations PCS1900 and EDGE Base Stations

PHS/PAS Base Stations Fixed Broadband

Applications

Wireless Access Wireless Local Loop Private Mobile Radio Military Systems

## Pin Configuration/ Functional Diagram



M/IXI/M

#### **Features**

**MAX9995** 

♦ 1700MHz to 2200MHz RF Frequency Range

- 1400MHz to 2000MHz LO Frequency Range (MAX9995)
- 1900MHz to 2400MHz LO Frequency Range (Contact Factory)
- ♦ 40MHz to 350MHz IF Frequency Range
- ♦ 6.1dB Conversion Gain
- +25.6dBm Input IP3
- 9.8dB Noise Figure
- 66dBc 2RF–2LO Spurious Rejection at P<sub>RF</sub> = -10dBm
- Dual Channels Ideal for Diversity Receiver Applications
- Integrated LO Buffer
- Integrated RF and LO Baluns for Single-Ended Inputs
- Low -3dBm to +3dBm LO Drive
- Built-In SPDT LO Switch with 50dB LO1–LO2 Isolation and 50ns Switching Time
- ♦ 44dB Channel-to-Channel Isolation

### **Ordering Information**

| PART          | TEMP RANGE   | PIN-PACKAGE                        |
|---------------|--|------------------------------------|
| MAX9995ETX    | $T_{C}^{**} = -40^{\circ}C \text{ to } +85^{\circ}C$     | 36 Thin QFN-EP*                    |
| MAX9995ETX-T  | $T_C = -40^{\circ}C \text{ to } +85^{\circ}C$            | 36 Thin QFN-EP*                    |
| MAX9995ETX+D  | $T_{\rm C} = -40^{\circ}{\rm C}$ to $+85^{\circ}{\rm C}$ | 36 Thin QFN-EP*<br>lead free, bulk |
| MAX9995ETX+TD | $T_{\rm C} = -40^{\circ}{\rm C}$ to $+85^{\circ}{\rm C}$ | 36 Thin QFN-EP*<br>lead free, T/R  |

\*EP = Exposed pad.

\*\* T<sub>C</sub> = Case temperature.

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\_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

## **ABSOLUTE MAXIMUM RATINGS**

| V <sub>CC</sub> 0.3V to +5.5V                             |  |
|---|--|
| LO1, LO2 to GND±0.3V                                      |  |
| IFM_, IFD_, IFM_SET, IFD_SET, LOSEL,                      |  |
| LO_ADJ_M, LO_ADJ_D to GND0.3V to (V <sub>CC</sub> + 0.3V) |  |
| RFMAIN, RFDIV, and LO_ Input Power+20dBm                  |  |
| RFMAIN, RFDIV Current (RF is DC shorted to GND through    |  |
| balun)  |  |

| Continuous Power Dissipation ( $T_A = +70^{\circ}C$ ) |                  |
|---|------------------|
| 36-Lead Thin QFN (derate 26mW/°C                      |                  |
| above +70°C)  | 2100mW           |
| θ」Α   | +38°C/W          |
| θJC   | +7.4°C/W         |
| Operating Temperature Range (Note A)TC                | = -40°C to +85°C |
| Maximum Junction Temperature Range                    | +150°C           |
| Storage Temperature Range                             | 65°C to +150°C   |
| Lead Temperature (soldering, 10s)                     | +300°C           |

**Note A:** T<sub>C</sub> is the temperature on the exposed paddle of the package.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **DC ELECTRICAL CHARACTERISTICS**

(*Typical Application Circuit*, no input RF or LO signals applied,  $V_{CC} = 4.75V$  to 5.25V,  $T_C = -40^{\circ}C$  to  $+85^{\circ}C$ . Typical values are at  $V_{CC} = 5.0V$ ,  $T_C = +25^{\circ}C$ , unless otherwise noted.)

| PARAMETER                | SYMBOL                | CONDITIONS                | MIN  | ТҮР | MAX  | UNITS |
|--------------------------|-----------------------|---------------------------|------|-----|------|-------|
| Supply Voltage           | Vcc                   |                           | 4.75 | 5   | 5.25 | V     |
|                          |                       | Total supply current      |      | 332 | 380  |       |
|                          |                       | V <sub>CC</sub> (pin 16)  |      | 82  | 90   |       |
| Supply Current           | ICC                   | V <sub>CC</sub> (pin 30)  |      | 97  | 110  | mA    |
|                          |                       | IFM+/IFM- (total of both) |      | 70  | 90   |       |
|                          |                       | IFD+/IFD- (total of both) |      | 70  | 90   |       |
| LOSEL Input High Voltage | VIH                   |                           | 2    |     |      | V     |
| LOSEL Input Low Voltage  | VIL                   |                           |      |     | 0.8  | V     |
| LOSEL Input Current      | $I_{IL}$ and $I_{IH}$ |                           | -10  |     | +10  | μA    |

### **AC ELECTRICAL CHARACTERISTICS**

(*Typical Application Circuit*, V<sub>CC</sub> = 4.75V to 5.25V, RF and LO ports are driven from 50 $\Omega$  sources, P<sub>LO</sub> = -3dBm to +3dBm, f<sub>RF</sub> = 1700MHz to 2200MHz, f<sub>LO</sub> = 1400MHz to 2000MHz, f<sub>IF</sub> = 200MHz, with f<sub>RF</sub> > f<sub>LO</sub>, T<sub>C</sub> = -40°C to +85°C. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>LO</sub> = 0dBm, f<sub>RF</sub> = 1900MHz, f<sub>LO</sub> = 1700MHz, f<sub>IF</sub> = 200MHz, and T<sub>C</sub> = +25°C, unless otherwise noted.) (Notes 1, 2)

| PARAMETER       | SYMBOL |                   | CONDITIONS   | MIN  | ТҮР | MAX  | UNITS |
|-----------------|--------|-------------------|--|------|-----|------|-------|
| RF Frequency    | fRF    | (Note 7)          |  | 1700 |     | 2200 | MHz   |
|                 | f. o   | (Note 7)          |  | 1400 |     | 2000 | MHz   |
| LO Frequency    | fLO    | (Contact factory) | (Note 7)   | 1900 |     | 2400 | MHz   |
| IF Frequency    | fı⊨    | 0                 | O frequency ranges;<br>ponents affect the IF<br>(Note 7) | 40   |     | 350  | MHz   |
|                 |        |                   | $f_{RF} = 1710MHz$ to 1875MHz                            |      | 6   |      |       |
| Conversion Gain | GC     |                   | f <sub>RF</sub> = 1850MHz to 1910MHz                     |      | 6.2 |      | dB    |
|                 |        |                   | $f_{RF} = 2110MHz$ to 2170MHz                            |      | 6.1 |      |       |

## AC ELECTRICAL CHARACTERISTICS (continued)

(*Typical Application Circuit*,  $V_{CC}$  = 4.75V to 5.25V, RF and LO ports are driven from 50 $\Omega$  sources,  $P_{LO}$  = -3dBm to +3dBm, f<sub>RF</sub> = 1700MHz to 2200MHz, f<sub>LO</sub> = 1400MHz to 2000MHz, f<sub>IF</sub> = 200MHz, with f<sub>RF</sub> > f<sub>LO</sub>, T<sub>C</sub> = -40°C to +85°C. Typical values are at V<sub>CC</sub> = 5.0V, P<sub>LO</sub> = 0dBm, f<sub>RF</sub> = 1900MHz, f<sub>LO</sub> = 1700MHz, f<sub>IF</sub> = 200MHz, and T<sub>C</sub> = +25°C, unless otherwise noted.) (Notes 1, 2)

| PARAMETER                               | SYMBOL           |   | CONDITIONS                  | 6                        | MIN | ТҮР   | MAX | UNITS |
|---|------------------|---|-----------------------------|--------------------------|-----|-------|-----|-------|
|   |                  | $V_{CC} = 5.0V,$<br>$T_{C} = +25^{\circ}C,$   | f <sub>RF</sub> = 1710      | MHz to 1875MHz           |     | ±0.5  | ±1  |       |
| Gain Variation from Nominal             |                  | $P_{LO} = 0 dBm,$<br>$P_{RF} = -10 dBm$   | f <sub>RF</sub> = 1850      | MHz to 1910MHz           |     | ±0.5  | ±1  | dB    |
|   |                  | (Note 3)  | f <sub>RF</sub> = 2110      | MHz to 2170MHz           |     | ±0.5  | ±1  |       |
| Gain Variation with Temperature         |                  |   |                             |                          |     | ±0.75 |     | dB    |
|   |                  | Nie le le elve ve   | f <sub>RF</sub> = 1710      | MHz to 1875MHz           |     | 9.7   |     |       |
| Noise Figure                            | NF               | No blockers<br>present  | f <sub>RF</sub> = 1850      | MHz to 1910MHz           |     | 9.8   |     | dB    |
|   |                  | present   | f <sub>RF</sub> = 2110      | MHz to 2170MHz           |     | 9.9   |     | ]     |
| Noise Figure (with Blocker)             |                  | 8dBm blocker tor<br>2000MHz, $f_{RF} = 1$<br>$P_{LO} = -3dBm$                             |                             |                          |     | 22    |     | dB    |
| Input 1dB Compression Point             | P <sub>1dB</sub> | (Note 3)  |                             |                          | 9.5 | 12.6  |     | dBm   |
| Input Third-Order Intercept Point       | IIP3             | (Notes 3, 4)  |                             |                          | 23  | 25.6  |     | dBm   |
| 2RF-2LO Spur Rejection                  | 2 x 2            | $f_{RF} = 1900MHz,$<br>$f_{LO} = 1700MHz,$  |                             | P <sub>RF</sub> = -10dBm |     | 66    |     | dBc   |
|   | 2 ~ 2            | $f_{SPUR} = 1800MHz$  | z (Note 3)                  | P <sub>RF</sub> = -5dBm  |     | 61    |     | UDC   |
| 3RF-3LO Spur Rejection                  | 3 x 3            | $f_{RF} = 1900MHz,$<br>$f_{LO} = 1700MHz,$  |                             | P <sub>RF</sub> = -10dBm | 70  | 88    |     | dBc   |
|   | 0.00             | f <sub>SPUR</sub> = 1766.7M   | Hz (Note 3)                 | $P_{RF} = -5 dBm$        | 60  | 78    |     | dDo   |
| Maximum LO Leakage at RF Port           |                  | $f_{LO} = 1400MHz to$   | o 2000MHz                   |                          |     | -29   |     | dBm   |
| Maximum 2LO Leakage at RF Port          |                  | $f_{LO} = 1400MHz to$   | o 2000MHz                   |                          |     | -17   |     | dBm   |
| Maximum LO Leakage at IF Port           |                  | $f_{LO} = 1400MHz$ to   | o 2000MHz                   |                          |     | -25   |     | dBm   |
| Minimum RF to IF Isolation              |                  | $f_{RF} = 1700MHz$ to   | o 2200MHz, fj               | F = 200MHz               |     | 37    |     | dB    |
| LO1-LO2 Isolation                       |                  | $P_{LO1} = 0 dBm, P_{LO1}$  | _ <sub>02</sub> = 0dBm (I   | Note 5)                  | 40  | 50.5  |     | dB    |
| Minimum Channel-to-Channel<br>Isolation |                  | P <sub>RF</sub> = -10dBm, R<br>power measured<br>relative to IFMAIN<br>all unused parts t | at IFDIV (IFM<br>N (IFDIV), | IÁIN),                   | 40  | 44    |     | dB    |
| LO Switching Time                       |                  | 50% of LOSEL to   | IF settled to               | within 2°                |     | 50    |     | ns    |
| RF Return Loss                          |                  |   |                             |                          |     | 14    |     | dB    |
|   |                  | LO port selected  |                             |                          |     | 18    |     |       |
| LO Return Loss                          |                  | LO port unselecte   | ed                          |                          |     | 21    |     | dB    |
| IF Return Loss                          |                  | LO driven at 0dB  | m, RF termina               | ated into 50 $\Omega$    |     | 21    |     | dB    |

Note 1: Guaranteed by design and characterization.

Note 2: All limits reflect losses of external components. Output measurements taken at IF outputs of Typical Application Circuit.

Note 3: Production tested.

Note 4: Two tones 3MHz spacing, -5dBm per tone at RF port.

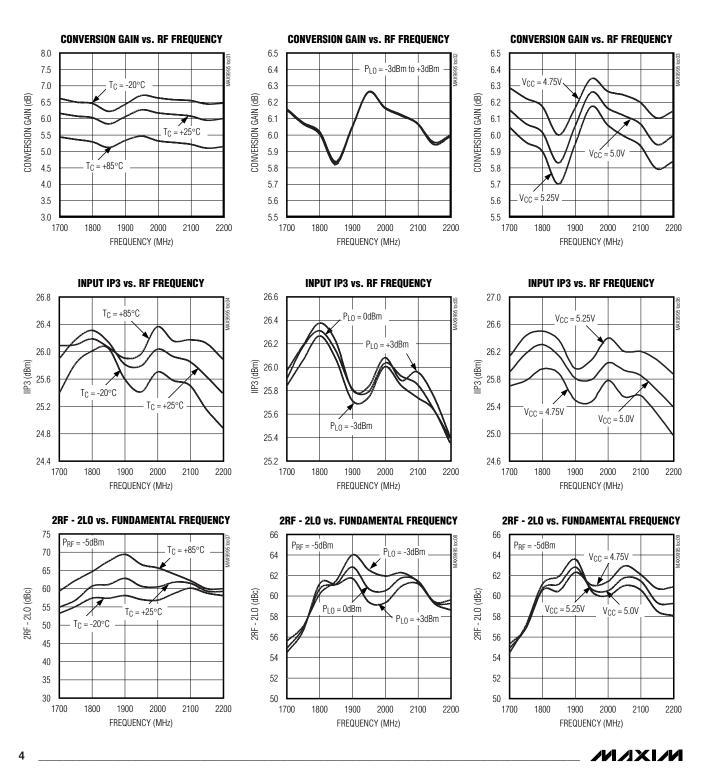
**Note 5:** Measured at IF port at IF frequency.  $f_{LO1}$  and  $f_{LO2}$  are offset by 1MHz.

Note 6: IF return loss can be optimized by external matching components.

Note 7: Operation outside this frequency band is possible but has not been characterized. See the *Typical Operating Characteristics*.

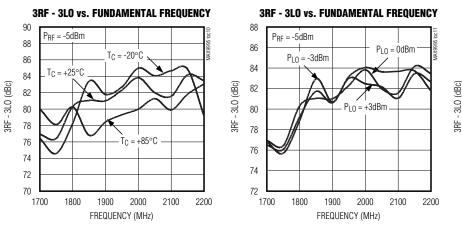
Typical Operating Characteristics

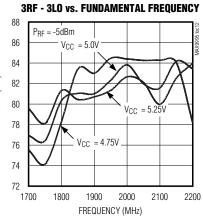
(*Typical Application Circuit*,  $V_{CC} = 5.0V$ ,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ , LO is low-side injected for a 200MHz IF,  $T_{C} = +25^{\circ}C$ .)

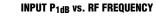


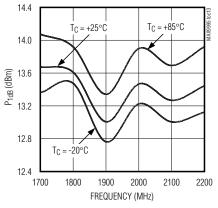
## **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*, V<sub>CC</sub> = 5.0V, P<sub>RF</sub> = -5dBm, P<sub>LO</sub> = 0dBm, LO is low-side injected for a 200MHz IF, T<sub>C</sub> = +25°C.)

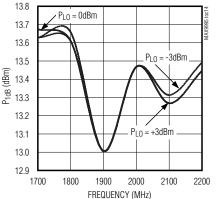




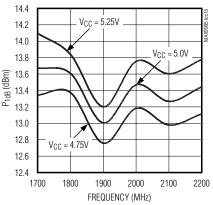


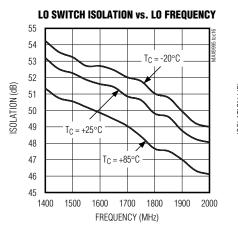


INPUT P<sub>1dB</sub> vs. RF FREQUENCY



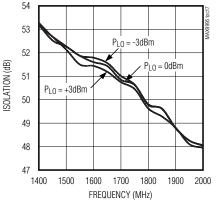
INPUT P1dB vs. RF FREQUENCY



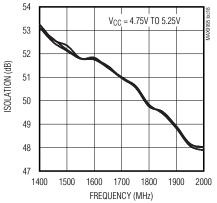


M/IXI/M

LO SWITCH ISOLATION vs. LO FREQUENCY



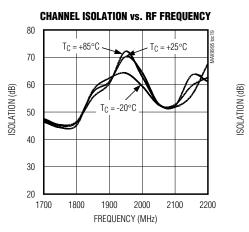
LO SWITCH ISOLATION vs. LO FREQUENCY



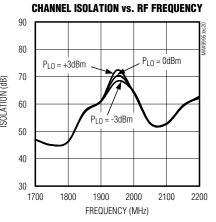
5

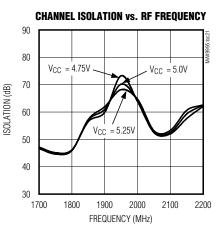


(*Typical Application Circuit*,  $V_{CC} = 5.0V$ ,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ , LO is low-side injected for a 200MHz IF,  $T_{C} = +25^{\circ}C$ .)

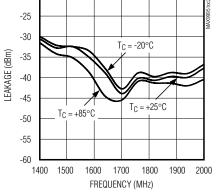


**MAX9995** 

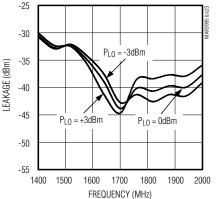








LO LEAKAGE AT IF PORT vs. LO FREQUENCY



LO LEAKAGE AT RF PORT vs. LO FREQUENCY

 $P_{LO} = -3dBm$ 

FREQUENCY (MHz)

1600 1700

 $P_{L0} = +3dBm$ 

 $P_{L0} = 0 dBm$ 

1900 2000

1800

-20

-25

-30

-35

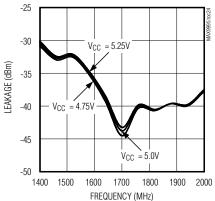
-40

-45

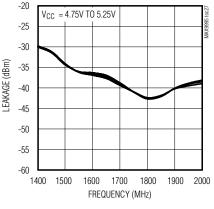
-50

1400 1500

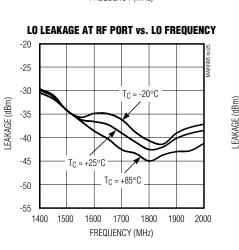
LO LEAKAGE AT IF PORT vs. LO FREQUENCY







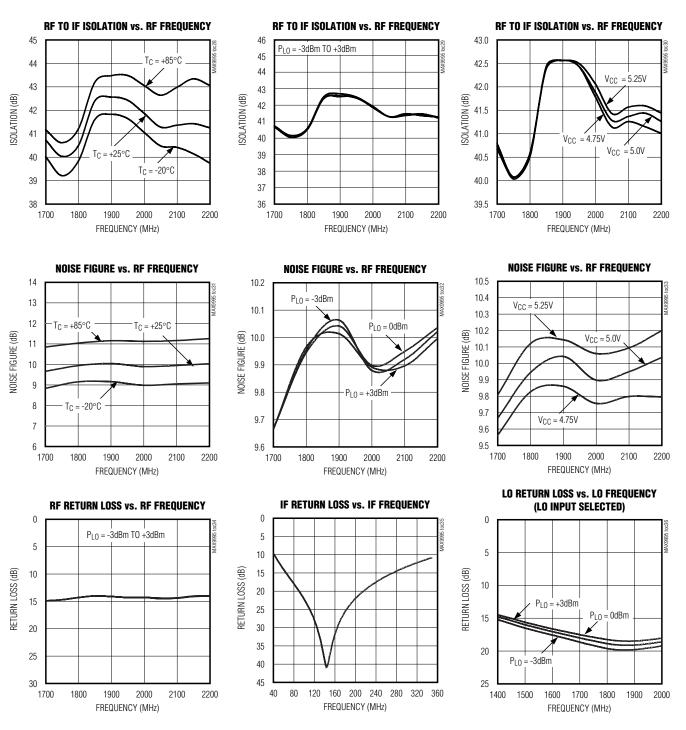
M/X/W



6

## **Typical Operating Characteristics (continued)**

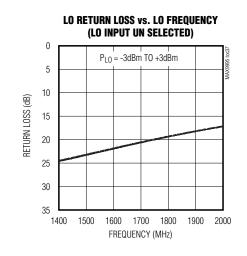
(*Typical Application Circuit*,  $V_{CC} = 5.0V$ ,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ , LO is low-side injected for a 200MHz IF,  $T_{C} = +25^{\circ}C$ .)

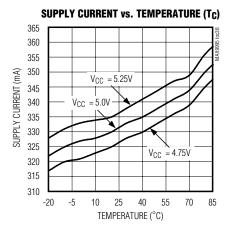


**MAX9995** 

### **Typical Operating Characteristics (continued)**

(*Typical Application Circuit*,  $V_{CC} = 5.0V$ ,  $P_{RF} = -5dBm$ ,  $P_{LO} = 0dBm$ , LO is low-side injected for a 200MHz IF,  $T_{C} = +25^{\circ}C$ .)





## **Pin Description**

M/IXI/M

| PIN                                    | NAME            | FUNCTION   |
|--|-----------------|--|
| 1                                      | RFMAIN          | Main Channel RF Input. Internally matched to $50\Omega$ . Requires an input DC-blocking capacitor.   |
| 2                                      | TAPMAIN         | Main Channel Balun Center Tap. Connect a 0.033µF capacitor from this pin to the board ground.  |
| 3, 5, 7, 12, 20, 22,<br>24, 25, 26, 34 | GND             | Ground   |
| 4, 6, 10, 16, 21, 30,<br>36            | V <sub>CC</sub> | Power Supply. Connect bypass capacitors as close to the pin as possible (see the <i>Typical Application Circuit</i> ).                                     |
| 8                                      | TAPDIV          | Diversity Channel Balun Center Tap. Connect a 0.033µF capacitor from this pin to the ground.   |
| 9                                      | RFDIV           | Diversity Channel RF Input. Internally matched to 50 $\Omega$ . Requires an input DC-blocking capacitor.   |
| 11                                     | IFD_SET         | IF Diversity Amplifier Bias Control. Connect a $1.2k\Omega$ resistor from this pin to ground to set the bias current for the diversity IF amplifier.       |
| 13, 14                                 | IFD+, IFD-      | Diversity Mixer Differential IF Output. Connect pullup inductors from each of these pins to V <sub>CC</sub> (see the <i>Typical Application Circuit</i> ). |
| 15                                     | IND_EXTD        | Connect a 10nH inductor from this pin to ground to increase the RF-IF and LO-IF isolation.   |
| 17                                     | LO_ADJ_D        | LO Diversity Amplifier Bias Control. Connect a $392\Omega$ resistor from this pin to ground to set the bias current for the diversity LO amplifier.        |
| 18, 28                                 | N.C.            | No Connection. Not internally connected.   |
| 19                                     | LO1             | Local Oscillator 1 Input. This input is internally matched to $50\Omega$ . Requires an input DC-blocking capacitor.  |
| 23                                     | LOSEL           | Local Oscillator Select. Set this pin to high to select LO1. Set to low to select LO2.   |

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## Pin Description (continued)

| PIN            | NAME       | DESCRIPTION   |
|----------------|------------|---|
| 27             | LO2        | Local Oscillator 2 Input. This input is internally matched to $50\Omega$ . Requires an input DC-blocking capacitor.                                   |
| 29             | LO_ADJ_M   | LO Main Amplifier Bias Control. Connect a $392\Omega$ resistor from this pin to ground to set the bias current for the main LO amplifier.             |
| 31             | IND_EXTM   | Connect a 10nH inductor from this pin to ground to increase the RF-IF and LO-IF isolation.  |
| 32, 33         | IFM-, IFM+ | Main Mixer Differential IF Output. Connect pullup inductors from each of these pins to V <sub>CC</sub> (see the <i>Typical Application Circuit</i> ). |
| 35             | IFM_SET    | IF Main Amplifier Bias Control. Connect a $1.2k\Omega$ resistor from this pin to ground to set the bias current for the main IF amplifier.            |
| Exposed Paddle | GND        | Exposed Ground Plane. This paddle affects RF performance and provides heat dissipation. The paddle must be connected to ground.                       |

## **Detailed Description**

The MAX9995 dual, high-linearity, downconversion mixer provides 6.1dB gain and +25.6dBm IIP3, with a 9.8dB noise figure. Integrated baluns and matching circuitry allow  $50\Omega$  single-ended interfaces to the RF and LO ports. A single-pole, double-throw (SPDT) LO switch provides 50ns switching time between LO inputs, with 50dB LO-to-LO isolation. Furthermore, the

| COMPONENT                       | VALUE           | DESCRIPTION                           |
|---------------------------------|-----------------|---------------------------------------|
| C1, C8                          | 4pF             | Microwave capacitors (0402)           |
| C2, C7                          | 10pF            | Microwave capacitors (0402)           |
| C3, C6                          | 0.033µF         | Microwave capacitors (0603)           |
| C4, C5, C14, C16                | 22pF            | Microwave capacitors (0402)           |
| C9, C13, C15,<br>C17, C18       | 0.01µF          | Microwave capacitors (0402)           |
| C10, C11, C12,<br>C19, C20, C21 | 150pF           | Microwave capacitors (0603)           |
| L1, L2, L4, L5                  | 330nH           | Wire-wound high-Q inductors<br>(0805) |
| L3, L6                          | 10nH            | Wire-wound high-Q inductors (0603)    |
| R1, R4                          | 1.21kΩ          | ±1% resistors (0402)                  |
| R2, R5                          | 392Ω            | ±1% resistors (0402)                  |
| R3, R6                          | 10Ω             | ±1% resistors (1206)                  |
| T1, T2                          | 4:1<br>(200:50) | IF baluns                             |

#### **Table 1. Component Values**



integrated LO buffer provides a high drive level to the mixer core, reducing the LO drive required at the MAX9995's inputs to -3dBm. The IF port incorporates a differential output, which is ideal for providing enhanced 2RF-2LO performance.

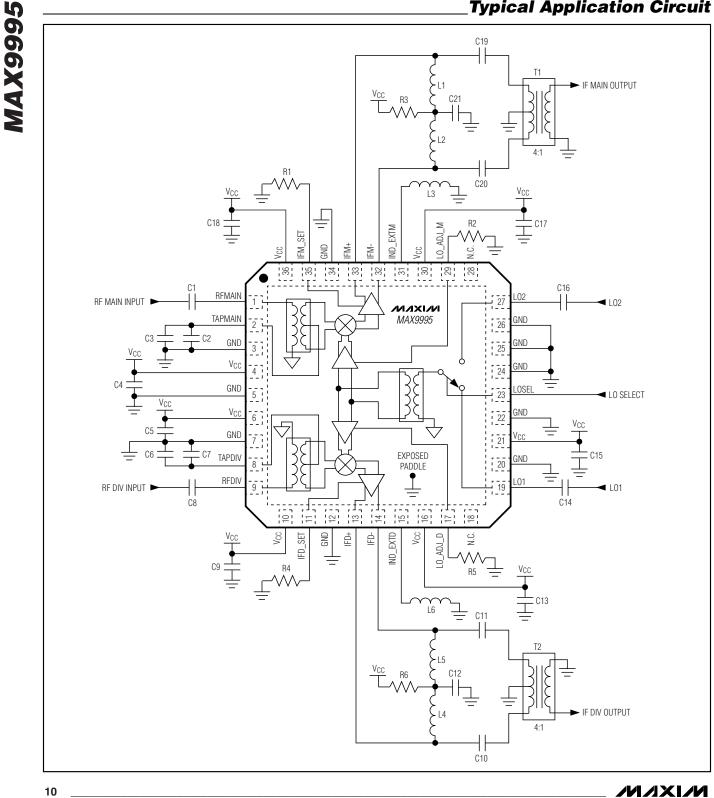
Specifications are guaranteed over broad frequency ranges to allow for use in UMTS/WCDMA and 2G/2.5G/3G DCS1800, PCS1900, and cdma2000 base stations. The MAX9995 is specified to operate over an RF input range of 1700MHz to 2200MHz, an LO range of 1400MHz to 2000MHz, and an IF range of 40MHz to 350MHz. Operation beyond this is possible; however, performance is not characterized. This device can operate in high-side LO injection applications with an extended LO range, but performance degrades as fLO continues to increase. For a device with better high-side performance, contact the factory. This device is available in a compact 6mm x 6mm, 36-pin thin QFN package with an exposed paddle.

#### **RF Input and Balun**

The MAX9995's two RF inputs (RFMAIN and RFDIV) are internally matched to  $50\Omega$ , requiring no external matching components. DC-blocking capacitors are required as the inputs are internally DC shorted to ground through the on-chip baluns. Input return loss is typically 14dB over the entire RF frequency range of 1700MHz to 2200MHz.

#### LO Input, Switch, Buffer, and Balun

The mixers can be used for either high-side or low-side injection applications with an LO frequency range of 1400MHz to 2000MHz. For a device with an LO frequency range of 1900MHz to 2400MHz, contact the factory. As an added feature, the MAX9995 includes an



**Typical Application Circuit** 

internal LO SPDT switch that can be used for frequency-hopping applications. The switch selects one of the two single-ended LO ports, allowing the external oscillator to settle on a particular frequency before it is switched in. LO switching time is typically less than 50ns, which is more than adequate for virtually all GSM applications. If frequency hopping is not employed, set the switch to either of the LO inputs. The switch is controlled by a digital input (LOSEL): logic high selects LO1, and logic low selects LO2. LO1 and LO2 inputs are internally matched to  $50\Omega$ , requiring only a 22pF DC-blocking capacitor.

A two-stage internal LO buffer allows a wide input power range for the LO drive. All guaranteed specifications are for an LO signal power from -3dBm to +3dBm. The on-chip low-loss balun, along with an LO buffer, drives the double-balanced mixer. All interfacing and matching components from the LO inputs to the IF outputs are integrated on-chip.

#### **High Linearity Mixers**

The core of the MAX9995 is a pair of double-balanced, high-performance passive mixers. Exceptional linearity is provided by the large LO swing from the on-chip LO buffer. When combined with the integrated IF amplifiers, the cascaded IIP3, 2RF-2LO rejection, and NF performance is typically +25.6dBm, 66dBc, and 9.8dB, respectively.

#### **Differential IF Output Amplifiers**

The MAX9995 mixers have an IF frequency range of 40MHz to 350MHz. The differential, open-collector IF output ports require external pullup inductors to V<sub>CC</sub>. Note that these differential outputs are ideal for providing enhanced 2RF-2LO rejection performance. Single-ended IF applications require a 4:1 balun to transform the 200 $\Omega$  differential output impedance to a 50 $\Omega$  single-ended output. After the balun, VSWR is typically 1.5:1.

#### \_Applications Information

#### **Input and Output Matching**

The RF and LO inputs are internally matched to  $50\Omega$ . No matching components are required. Return loss at each RF port is typically 14dB over the entire input range (1700MHz to 2200MHz), and return loss at the LO ports is typically 18dB (1400MHz to 2000MHz). RF and LO inputs require only DC-blocking capacitors for interfacing.

The IF output impedance is  $200\Omega$  (differential). For evaluation, an external low-loss 4:1 (impedance ratio) balun transforms this impedance down to a  $50\Omega$  single-ended output (see the *Typical Application Circuit*).

#### **Bias Resistors**

Bias currents for the LO buffer and the IF amplifier are optimized by fine tuning the resistors R1, R2, R4, and R5. If reduced current is required at the expense of performance, contact factory. If the  $\pm 1\%$  bias resistor values are not readily available, substitute standard  $\pm 5\%$  values.

#### **Layout Considerations**

A properly designed PC board is an essential part of any RF/microwave circuit. Keep RF signal lines as short as possible to reduce losses, radiation, and inductance. For the best performance, route the ground pin traces directly to the exposed pad under the package. The PC board exposed pad **MUST** be connected to the ground plane of the PC board. It is suggested that multiple vias be used to connect this pad to the lower-level ground planes. This method provides a good RF/thermal-conduction path for the device. Solder the exposed pad on the bottom of the device package to the PC board. The MAX9995 Evaluation Kit can be used as a reference for board layout. Gerber files are available upon request at www.maxim-ic.com.

#### **Power-Supply Bypassing**

Proper voltage-supply bypassing is essential for high-frequency circuit stability. Bypass each V<sub>CC</sub> pin with a capacitor as close to the pin as possible (*Typical Application Circuit*).

#### **Exposed Pad RF/Thermal Considerations**

The exposed paddle (EP) of the MAX9995's 36-pin thin QFN-EP package provides a low thermal-resistance path to the die. It is important that the PC board on which the MAX9995 is mounted be designed to conduct heat from the EP. In addition, provide the EP with a low-inductance path to electrical ground. The EP **MUST** be soldered to a ground plane on the PC board, either directly or through an array of plated via holes.

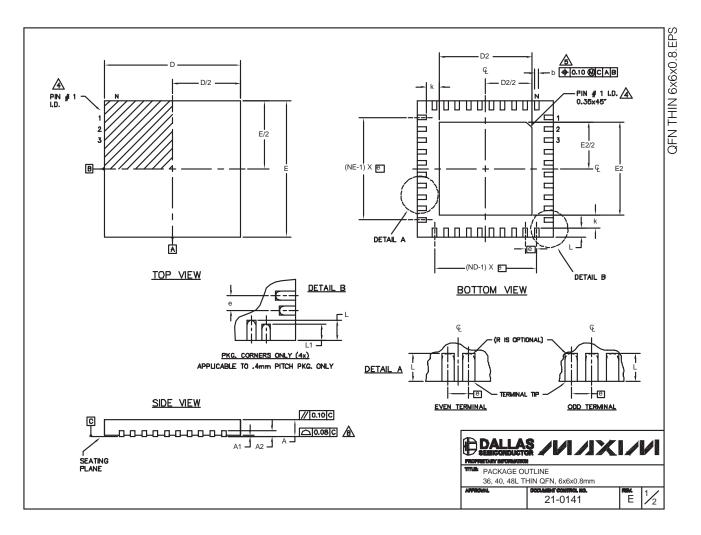
#### **Chip Information**

TRANSISTOR COUNT: 1414 PROCESS: SiGe BiCMOS



#### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



**MAX9995** 

## Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)

|   |   |  | cc  | MMON   | DIMENS   | IONS  |   |  |   |   |                              | EXPO | sed pa | d vari/ | TIONS |      |      | DOWN      |
|---|---|--|---|--|--|---|---|--|---|---|------------------------------|------|--------|---------|-------|------|------|-----------|
| PKG.  | 1   | 36L 6x6  | i   |  | 40L 6x6  | i   |   | 48L 6x6  |   |   | PKG.                         |      | DZ     |         |       | E2   |      | BONDS     |
| SYMBOL  | MIN.  | NOM.   | MAX.  | MIN.   | NOM.   | MAX.  | MIN.  | NOM.   | MAX.  | 1   | CODES                        | MIN. | NOM.   | MAX.    | MIN.  | NOM. | MAX. |           |
| A   | 0.70  | 0.75   | 0.80  | 0.70   | 0.75   | 0.80  | 0.70  | 0.75   | 0.80  | 1   | T3666-1                      | 3.60 | 3.70   | 3.80    | 3.60  | 3.70 | 3.80 | NO        |
| A1  | 0   | 0.02   | 0.05  | 0  | 0.02   | 0.05  | 0   | -  | 0.05  | 1   | T3666-2                      | 3.60 | 3.70   | 3.80    | 3.60  | 3.70 | 3.80 | YES       |
| A2  |   | 0.20 REF   |   |  | 0.20 REF.  |   |   | 0.20 REF   | •   |   | T3666-3                      | 3.60 | 3.70   | 3.80    | 3.60  | 3.70 | 3.80 | NO        |
| b   | 0.20  | 0.25   | D.3D  | 0.20   | 0.25   | 0.30  | 0.15  | 0.20   | 0.25  |   | T4066-1                      | 4.00 | 4.10   | 4.20    | 4.00  | 4.10 | 4.20 | NO        |
| D   | 5.90  | 6.00   | 6.10  | 5.90   | 6.00   | 6.10  | 5.90  | 6.00   | 6.10  |   | T4066-2                      | 4.00 | 4.10   | 4.20    | 4.00  | 4.10 | 4.20 | YES       |
| E   | 5.90  | 6.DD   | 6.10  | 5.90   | 6.00   | 6.10  | 5.90  | 6.00   | 6.10  |   | T4066-3                      | 4.00 | 4.10   | 4.20    | 4.00  | 4.10 | 4.20 | YES       |
| e   |   | 0.50 BSC   |   |  | 0.50 BSC.  | I   |   | 0.40 BSC   |   |   | T4066-4                      | 4.00 | 4.10   | 4.20    | 4.00  | 4.10 | 4.20 | NO        |
| k   | 0.25  | -  | -   | 0.25   | -  | -   | 0.25  | 0.35   | 0.45  |   | T4066-5                      | 4.00 | 4.10   | 4.20    | 4.00  | 4.10 | 4.20 | NO        |
| L   | 0.45  | 0.55   | D.65  | 0.30   | 0.40   | 0.50  | 0.40  | 0.50   | 0.60  |   | T4866-1                      | 4.20 | 4.30   | 4.40    | 4.20  | 4.30 | 4.40 | YES       |
| LI  | -   | -  | -   | -  | -  | -   | 0.30  | 0.40   | 0.50  |   |                              |      |        |         |       |      |      |           |
| N   |   |  |   |  | 40   |   |   | 48   |   |   |                              |      |        |         |       |      |      |           |
|   |   | 36   |   |  |  |   |   |  |   |   |                              |      |        |         |       |      |      |           |
| ND  |   | 9  |   |  | 10   |   |   | 12   |   |   |                              |      |        |         |       |      |      |           |
| ND<br>NE<br>JEDEC   |   | 9<br>9<br>WJJD-1   |   |  | 10<br>10<br>WJJD-2   |   |   | 12<br>12<br>-  |   |   |                              |      |        |         |       |      |      |           |
| ND<br>NE<br>JEDEC   | NSIONS<br>TOTAL N<br>MINAL #1<br>DETAILS<br>ICATED.<br>IN b APP<br>RMINAL<br>VE REFE<br>LATION I              | 9<br>9<br>WJJD-1<br>TOLERA<br>ARE IN N<br>UMBER<br>IDENTIF<br>S OF TER<br>THE TEI<br>LIES TO<br>TIP.<br>R TO TH<br>S POSSII              | AILLIMET<br>OF TERM<br>IER AND<br>MINAL #<br>RMINAL #<br>METALLI<br>E NUMBE<br>BLE IN A | ERS. AN<br>IINALS.<br>TERMIN<br>1 IDENT<br>11 IDENT<br>2ED TE<br>ER OF TI<br>SYMME         | 10<br>10<br>WJJD-2<br>M TO AS<br>IGLES AI<br>IFIER AF<br>IFIER M<br>RMINAL<br>ERMINAL                                      | RE IN DE<br>IBERING<br>RE OPTIC<br>AY BE EI<br>AND IS N<br>LS ON EA<br>FASHION              | CONVE<br>NAL, BU<br>ITHER A<br>MEASUR<br>ACH D A                  | 12<br>12<br>12<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | " BE LOC/<br>DR MARKI<br>WEEN 0.2<br>DE RESPE | ATED WIT<br>ED FEATU<br>25 mm ANE<br>ECTIVELY             | JRE.<br>0 0.30 mm            |      | DAI    |         | S     |      |      | <b>×I</b> |
| ND<br>NE<br>JEDEC<br>DIMENSIC<br>ALL DIMEI<br>N IS THE<br>THE TERM<br>SPP-012.<br>ZONE IND<br>DIMENSIC<br>FROM TEI<br>ND AND I<br>DEPOPUI | NSIONS<br>TOTAL N<br>MINAL #1<br>DETAILS<br>ICATED.<br>ON 6 APP<br>RMINAL<br>VE REFE<br>LATION 12<br>ARITY AF | 9<br>9<br>WJJD-1<br>TOLERA<br>ARE IN N<br>UMBER I<br>IDENTIF<br>S OF TER<br>THE TEI<br>LIES TO<br>TIP.<br>R TO TH<br>S POSSII<br>PLIES T | MILLIMET<br>OF TERN<br>IER AND<br>IMINAL #<br>METALLI<br>E NUMBE<br>BLE IN A<br>O THE E | ERS. AN<br>IINALS.<br>TERMIN<br>1 IDENT<br>11 IDENT<br>2ED TE<br>2ED TE<br>SYMME<br>(POSED | 10<br>10<br>WJJD-2<br>M TO AS<br>IGLES AI<br>IGLES AI<br>IFIER AF<br>FIFIER M<br>RMINAL<br>ERMINAL<br>TRICAL I<br>0 HEAT S | RE IN DE<br>IBERING<br>RE OPTIC<br>IAY BE EI<br>AND IS N<br>LS ON EA<br>FASHION<br>SINK SLU | CONVE<br>DNAL, BI<br>ITHER A<br>MEASUR<br>ACH D A<br>J.<br>G AS W | 12<br>12<br>12<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>-<br>- | BE LOC/<br>DR MARKI<br>VEEN 0.2<br>DE RESPE   | ATED WIT<br>ED FEATU<br>25 mm ANE<br>ECTIVELY<br>/IINALS. | HIN THE<br>JRE.<br>D 0.30 mm |      |        |         | 1     |      |      | ×I        |

**MAX9995** 

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